

U.S. Department of Commerce, Patent and Trademark Office					Atty Docket No.		Serial No.	
					M-9506 US		09/757,559	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary)					Applicant			
					Tredinnick, Bruce			
					Filing Date		Group	
					January 9, 2001		unknown	
U.S. Patent Documents								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
K-cc	AA	5,614,444	Mar. 25, 1997	Farkas et al.	438	693	—	
K-cc	AB	5,773,364	Jun. 30, 1998	Farkas et al.	438	692	—	
K-cc	AC	5,980,775	Nov. 9, 1999	Grumbine et al.	252	79.1	—	
K-cc	AD	6,068,787	May 30, 2000	Grumbine et al.	252	79.1	—	
Foreign Patent Documents								
							Translation	
		Document	Date	Country	Class	Subclass	Yes	No
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)								
	AE	Results of Search by NERAC Inc., bearing date of December 12, 1996 (19 pages) containing items AE-AX:						
K-cc	AF	1) Abstract and bibliographic information concerning European Patent Application No. 95102959 (1995-03-02)						
K-cc	AG	2) Abstract and bibliographic information concerning European Patent Application No. 93101519 (1993-02-01)						
K-cc	AH	3) Abstract and bibliographic information concerning European Patent Application No. 93102979 (1993-02-25)						
K-cc	AI	4) Abstract and bibliographic information concerning European Patent No. 00455031 (1995-11-22)						
K-cc	AJ	5) Abstract and bibliographic information concerning European Patent No. 00455032 (1995-11-08)						
K-cc	AK	6) Abstract and bibliographic information concerning U. S. Patent No. 5,540,810 (1996-07-30)						
K-cc	AL	7) Abstract and bibliographic information concerning U. S. Patent No. 5,516,346 (1996-05-14)						
K-cc	AM	8) Abstract and bibliographic information concerning U. S. Patent No. 5,503,962 (1996-04-02)						
K-cc	AN	9) Abstract and bibliographic information concerning U. S. Patent No. 5,403,779 (1995-04-04)						
K-cc	AO	10) Abstract and bibliographic information concerning U. S. Patent No. 5,354,712 (1994-10-11)						
K-cc	AP	11) Abstract and bibliographic information concerning U. S. Patent No. 5,340,370 (1994-08-23)						
K-cc	AQ	12) Abstract and bibliographic information concerning U. S. Patent No. 5,314,843 (1994-05-24)						
K-cc	AR	13) Abstract and bibliographic information concerning U. S. Patent No. 5,300,155 (1994-04-05)						

K-cc	AS	14) Abstract and bibliographic information concerning U. S. Patent No. 5,271,798 (1993-12-21)
K-cc	AT	15) Abstract and bibliographic information concerning U. S. Patent No. 5,262,354 (1993-11-16)
K-cc	AU	16) Abstract and bibliographic information concerning U. S. Patent No. 5,244,534 (1993-09-14)
K-cc	AV	17) Abstract and bibliographic information concerning U. S. Patent No. 5,222,329 (1993-06-29)
K-cc	AW	18) Abstract and bibliographic information concerning U. S. Patent No. 4,554,216 (1985-11-19)
K-cc	AX	19) Abstract and bibliographic information concerning U. S. Patent No. 4,101,707 (1978-07-18)
K-cc	AY	Results of Search of NERAC Inc., bearing date of January 10, 2002 (46 pages) containing items AY-CQ:
K-cc	AZ	1) Bibliographic information concerning Japanese Patent No. 2001308096 (2001-11-02)
K-cc	BA	2) Bibliographic information concerning journal article Dianhuaxue Vol. 7 No. 2 (2001) (pp. 189-194)
K-cc	BB	3) Bibliographic information concerning Japanese Patent No. 2001210612 (2001-08-03)
K-cc	BC	4) Bibliographic information concerning German Patent No. 19959711 (2001-06-21)
K-cc	BD	5) Bibliographic information concerning PCT International Patent No. 0117008 (2001-03-08)
K-cc	BE	6) Bibliographic information concerning journal article Jpn. J. Appl. Phys. Part 1 Vol. 39 No. 11 (2000) (pp. 6216-6222)
K-cc	BF	7) Bibliographic information concerning U. S. Patent No. 6,153,526 (2000-11-28)
K-cc	BG	8) Bibliographic information concerning U. S. Patent No. 6,143,656 (2000-11-07)
K-cc	BH	9) Bibliographic information concerning U.S. Patent No. 6,136,693 (200-10-24)
K-cc	BI	10) Bibliographic information concerning U.S. Patent No. 6,136,711 (2000-10-24)
K-cc	BJ	11) Bibliographic information concerning Japanese Patent No. 2000160138 (2000-06-13)
K-cc	BK	12) Bibliographic information concerning PCT International Patent No. 0031794 (2000-06-02)
K-cc	BL	13) Bibliographic information concerning Japanese Patent No. 2000144109 (2000-05-26)
K-cc	BM	14) Bibliographic information concerning PCT International Patent No. 0028585 (2000-05-18)
K-cc	BN	15) Bibliographic information concerning Japanese Patent No. 200012543 (2000-01-14)
K-cc	BO	16) Bibliographic information concerning PCT International Patent No. 9961540 (1999-12-02)
K-cc	BP	17) Bibliographic information concerning U. S. Patent No. 5,981,378 (1999-11-09)
K-cc	BQ	18) Bibliographic information concerning U. S. Patent No. 5,972,793 (1999-10-26)
K-cc	BR	19) Bibliographic information concerning PCT International Patent No. 9953532 (1999-10-21)
K-cc	BS	20) Bibliographic information concerning journal article J. Vac. Sci. Technol., Vol. 17 No. 4, Pt 1 (1999) (pp. 1168-1173)
K-cc	BT	21) Bibliographic information concerning U.S. Patent No. 5,913,141 (1999-06-15)
K-cc	BU	22) Bibliographic information concerning U. S. Patent No. 5,906,949 (1999-05-25)
K-cc	BV	23) Bibliographic information concerning journal article J. Electrochem. Soc. Vol. 146 No. 4 (1999) (pp. 1442-1447)
K-cc	BW	24) Bibliographic information concerning United Kingdom Patent No. 2326523 (1998-12-23)
K-cc	BX	25) Bibliographic information concerning PCT International Patent No. 9905706 (1999-02-04)
K-cc	BY	26) Bibliographic information concerning PCT International Patent No. 9854756 (1998-12-03)
K-cc	BZ	27) Bibliographic information concerning Japanese Patent No. 98284596 (1998-10-23)
K-cc	CA	28) Bibliographic information concerning PCT International Patent No. 9842791 (1998-10-01)
K-cc	CB	29) Bibliographic information concerning PCT International Patent No. 9842790 (1998-10-01)

K-CC	CC	30) Bibliographic information concerning journal article J. Electrochem. Soc. Vol. 145 No. 4 (1998) (pp. 1285-1291)
K-CC	CD	31) Bibliographic information concerning PCT International Patent No. 9804646 (1998-02-05)
K-CC	CE	32) Bibliographic information concerning journal article Microelectron. Eng. Vol. 37/38 (1997) (pp. 237-243)
K-CC	CF	33) Bibliographic information concerning journal article Microelectron. Eng. Vol. 37/38 (1997) (pp. 347-352)
K-CC	CG	34) Bibliographic information concerning journal article J. Electrochem. Soc. Vol. 144 No. 9 (1997) (pp. 3041-3049)
K-CC	CH	35) Bibliographic information concerning journal article Proc. - Electrochem. Soc. Vol. 99-22 (1997) (pp. 70-78)
K-CC	CI	36) Bibliographic information concerning journal article Microelectron. Eng. Vol. 33 No. 1-4 (1997) (pp. 249-257)
K-CC	CJ	37) Bibliographic information concerning journal article Proc. - Electrochem. Soc. Vol. 95-20 (1996) (pp. 581-588)
K-CC	CK	38) Bibliographic information concerning journal article App. Surf. Sci. Vol. 91 No. 1-4 (1995) (pp. 192-6)
K-CC	CL	39) Abstract and bibliographic information concerning "Contamination and Galvanic Corrosion in Metal, Chemical-Mechanical, Planarization (Tungsten, Copper)," (1998) Vol. 59-11B (pp. 6028)
K-CC	CM	40) Abstract and bibliographic information concerning Journal of the Electrochemical Society Vol. 143 No. 12 (December 1996) (pp. 4095-4100)
K-CC	CN	41) Abstract and bibliographic information concerning European Semiconductor Vol. 22 No. 4 (April 2000) (pp. 51-2, 54)
K-CC	CO	42) Abstract and bibliographic information concerning Twenty Third IEEE/CPMT International Electronics Manufacturing Technology Symposium (Cat. 98CH36205) (1998) (pp. 164-71)
K-CC	CP	43) Abstract and bibliographic information concerning 1996 Proceedings Thirteenth International VLSI Multilevel Interconnection Conference (VMIC) (1996) (pp. 381-6)
K-CC	CQ	44) Abstract and bibliographic information concerning Proceedings of the First International Symposium on Chemical Mechanical Planarization (1997) (pp. 137-489)
Examiner	Kin-IL CHEN	
Date Considered	02-16-02	
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.		

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